



Technical Data Sheet

4/14/2018

Tile Adhesive

Description: High-strength, trowelable adhesive compound that cures at room temperature

Intended Use: Bonding ceramic tile to vertical, curved, and overhead surfaces; repairing loose ceramic tiles

Product Easy to use 1:1 formula features: Supports 4 lbs./sg, ft wh

Supports 4 lbs./sq. ft while curing Excellent acid and alkali resistance

Non-sagging

Excellent adhesion to metal, ceramic, and concrete

Limitations:

None

Typical Physical Properties: Technical data should be considered representative or typical only and should not be used for specification purposes.

Cured 7 days @ 75° F

Mixed Viscosity

Tensile Strength

Pot Life @ 75F

Adhesive Tensile Shear 1.945 psi Coefficient of Thermal Expansion 14 [(in.) / (in). x °F)] x 10(-6) Color White **Compresive Strength** 9,620 psi Coverage/Ib 76.8 sq.in./lb. @ 1/4" **Cured Density** 1.45 gm/cc **Cured Hardness** 81D **Cured Shrinkage** 0.0010 in./in. **Dielectric Constant** Flexural Strength 5,480 psi **Functional Cure** 8 - 12 hrs. Mix Ratio by Volume 1:1 Mix Ratio by Weight 1.1:1

Recoat Time 11 - 16 hrs.
Solids by Volume 100
Specific Volume 19.2 in.(3)/lb.
Temperature Resistance 200°F

TESTS CONDUCTED

Adhesive Tensile Shear ASTM D 1002 Cured Hardness Shore D ASTM D 2240 Coef. of Thermal Expansion ASTM D 696 Dielectric Constant ASTM D 150 Flexural Strength ASTM D 790 Thermal Conductivity ASTM C 177 Compressive Strength ASTM D 695 Cure Shrinkage ASTM D 2566 Dielectric Strength, volts/mil ASTM D 149 Modulus of Elasticity ASTM D 638

Surface Preparation:

1. Thoroughly clean the surface with Devcon® Cleaner Blend 300 to remove all oil, grease and dirt.

2,640 psi

Putty

4 hrs.

2. Grit blast surface area with 8-40 mesh grit, or grind with a coarse wheel or abrasive disc pad, to create increased surface area for better adhesion (Caution: An abrasive disc pad can only be used provided white metal is revealed). Desired profile is 3-5mil, including defined edges (do not "feather-edge" epoxy).

Note: For metals exposed to sea water or other salt solution, grit-blast and high-pressure-water-blast the area, then leave overnight to allow any salts in the metal to "sweat" to the surface. Repeat blasting to "sweat out" all soluble salts. Perform chloride contamination test to determine soluble salt content (should be no more than 40ppm).

- 3. Clean surface again with Devcon® Cleaner Blend 300 to remove all traces of oil, grease, dust or other foreign substances from the grit blasting.
- 4. Repair surface as soon as possible to eliminate any changes or surface contaminants.

WORKING CONDITIONS: Ideal application temperature is 55°F to 90°F. In cold working conditions, directly heat repair area to100-110°F prior to applying epoxy and maintain at this temperature during product cure to dry off any moisture, contamination or solvents, as well as to achieve maximum performance properties.



Mixing Instructions:

---- It is strongly recommended that full units be mixed, as ratios are pre-measured. ----

- 1. Add hardener to resin.
- 2. Mix thoroughly with screwdriver or similar tool (continuously scrape material away from sides and bottom of container) until a uniform, streak-free consistency is obtained.

INTERMEDIATE SIZES (1,2,3 lb. units): Place resin and hardener on a flat, disposable surface such as cardboard, plywood or plastic sheet. Use a trowel or wide-blade tool to mix the material as in Step 2 above.

LARGE SIZES: (25 lb., 30 lb., 50 lb. buckets): Use a T-shaped mixing paddle or a propeller-type Jiffy Mixer Model ES on an electric drill. Thoroughly fold putty by vigorously moving paddle/propeller up and down until a homogenous mix of resin and hardener is attained.

Application Instructions:

Apply Tile Adhesive with either a smooth or notched trowel.

TO APPLY:

- 1. Apply Tile Adhesive to base.
- 2. Press tile form from its center outward to force out excess resin and eliminate air entrapment.
- 3. Pound tile with a rubber hammer to ensure a close fit.
- 4. Scrape excess adhesive from tile seams.

ADDITIONAL INFORMATION:

- -Tile Adhesive has a very high green strength, which means that tiles will not slip during the cure process unless excessive adhesive has been applied or air has become entrapped under the tile.
- -Applying epoxy at temperatures below 70°F lengthens functional cure and pot life times. Conversely, applying above 70°F shortens functional cure and pot life.
- -Tile Adhesive fully cures in 16 hours, at which time it can be machined, drilled or painted.

Storage: Store at room temperature, 70 °F.

Compliances: None

Chemical Resistance:

Rating chemical resistance is not necessary for this product.

Precautions: Please refer to the appropriate safety data sheet (SDS) prior to using this product.

For technical assistance, please call 1-855-489-7262

FOR INDUSTRIAL USE ONLY

Warranty:

ITW Performance Polymers will replace any material found to be defective. Because the storage, handling and application of this material is beyond our control, we can accept no liability for the results obtained.

Disclaimer:

All information on this data sheet is based on laboratory testing and is not intended for design purposes. ITW Performance Polymers makes no representations or warranties of any kind concerning this data.

Order Information:

11495 20 lb.